

Hands Electronics

Tegryn Llanfyrnach Dyfed
SA35 0BL Tel 023977 427

Thank you for purchasing one of our kits. We hope it will give you many hours of service once built. Our aim is to provide satisfaction and service. If you have any problems with the construction or use of the equipment, please ring, or write to us. We will do all we can to help. If you are new to construction we suggest you read carefully the about part identity and soldering contained in the tools and construction section.

Sheldon Hands

Tools and Construction Practice

We recommend the following tools to make your HANDS kit

- 15/25w soldering iron
- small electrical screwdriver
- 4inch phillips screwdriver
- small side cutters
- electricians pliers
- snipe nosed pliers
- small half round file
- multimeter

Below are some notes on construction practice with a heavy emphasis on soldering.

You must use solder with a non-corrosive flux. Acid cored solder MUST NOT be used. A 60/40 type will be ideal. The secret of good soldering is to have the correct temperature at the joint. Make sure the tip of the iron is clean, if necessary clean it on a damp sponge. Do not carry solder on the iron to the joint, by the time you get it there the flux will have burnt or vaporised.

Although it seems to contradict the above, do lightly tin the iron before making a joint. This will aid the heat transfer and lessen the chance of damage to the track or component through prolonged application of the iron. When you are ready to make the joint, apply the iron and the solder at the same time. Do not apply too much solder, a thin gauge helps in this respect. Humps of solder on a joint either means you did not leave the iron on the joint long enough or you used too much solder.

Try to get a medium coating over the track and the component lead. If you use too much heat you may damage the track or the component. We suggest you try some test joint on scrap wire, you will find it inspires confidence! When the board is complete check for solder bridges and dry joints, an Ohmmeter can be used for checks.

Most large parts in the kit are readily identifiable, but value identification systems are varied and may pose a problem. For wire ended resistors (ie not SMD) a colour code chart is included at the back of the manual. Most supplies of resistors are coded with 3 bands for the value, i.e. 1st fig, 2nd fig, 3rd multiplier. But we increasingly receive resistors with a 4 band code this then becomes 1st fig, 2nd fig, 3rd fig, 4th multiplier e.g 1k5 = brown, green, black, brown = 1 5 0 0.

Capacitor identification for electrolytics is straight forward but ceramic caps may pose a problem. Where n values are used n10 = 100pf and 1n = 1000pf, those with just a 3 digit number use the first 2 numbers as figures and the 3rd indicating the number of zeros, i.e. 102 = 1000pf. For those with a 3 digit number followed by letters treat as a 3 digit number, where only 2 digits and a letter are used this indicates the value is less than 100pf i.e. 82J = 82pf and 4.7C = 4.7pf.

Inductor value systems are as varied as capacitors but generally there are two common types. The first uses coloured bands with the same colour values as resistors, the inductors are the same length as a 0.25w resistor but much thicker with flat ends where the lead exits the body. If

checked with an ohmmeter they will show very low resistance values. The second type have the value marked on them with an alpha-numeric code in uh e.g. 2R2K = 2.2uh and 220J = 22uh.

Circuit Description

The RTX PLL6 is a phase locked loop synthesizer primarily designed to provide local oscillator output for use with the Hands 6RMX and 6TMX mixer boards. The reference for the system is an external vfo running at 5-5.5mhz, the stability of the system is dependant on this reference.

TR3 a-f with their associated components form 6 crystal oscillators. The oscillator is resonated by L4/C26 at the wanted output frequency. On some bands capacitive feedback is used from the divider C25/27. D7/R21 damp the output voltage, the output is a series feed through

the crystal to obtain a degree of filtering. The oscillators are buffered by TR4 a grounded gate amplifier.

TR2 a-f are the VCO oscillators. The tuned circuit is comprised of L3 resonated by the variable capacitance diode D5, on some bands to obtain the minimum capacitance required the circuit is padded by C19. Feedback is controlled by the capacitive divider C21/22. D6a-f isolates the individual oscillators and are biased on when 12v from the bandswitch is applied to the select line via R19. The DC voltage to the varicap diode is supplied from the loop filter/amp IC3.

IC1 an NE602AN mixes a portion of the synth output frequency with one of the on board crystal oscillators. The difference frequency f1-f2 when the system is in lock will be equal to the external VFO. The mixer output is transformer coupled to the low pass filter L1-2/C5,6,7, which attenuates the higher products of the mix process. The wanted output is amplified by TR1 feedback stage.

IC2 is a 74H4046, the phase comparator section of the ic is used to compare the frequency and phase of the external VFO and IC1 mixer output. The comparison generates a voltage at pin 13 of the ic, when the phase of the two signals are the same the circuit is considered to be in 'lock'. The voltage at pin 13 with the system locked will then be the mean of the voltage swing. If the VCO drifts or the VFO frequency is changed the voltage on pin 13 will change and attempt to find a new mean point for 'lock'. The voltage at pin 13 on IC2 is filtered in ICa and buffered by IC3b, the dc voltage is then applied to D6 to vary the VCO frequency.

The control loop operates as a subtractor. If alternative vco outputs are added the xtal oscillator frequency must be higher than the vco frequency.

The synthesizer output frequency is amplified and buffered by a cascade amplifier comprising TR5/6.

Construction

- Fit the pcb pins listed below. Push the pins home from the track side with a hot soldering iron. Always support the board around the pin with an old cotton or solder reel during this operation.
- Pcb Pins:- + 12v, SYN OUT, TP1(2 OFF), BSa-f, VFO. Optionally you may add EXT OSC, TUN and VCO
- Fit and solder R1-R33. Check the appendix for the correct way to fit components. Where you see a ground legend on a resistor this end is soldered to the top foil of the pcb termed GROUNDPLANE. The groundplane acts as a large heat sink so always tin the pcb with solder around the area of the connection first. Cut the ground side resistor lead back to about 3mm before fitting. If the connections are

too long and obstruct another pad angle the component to a free area of groundplane.

- Fit and solder the ceramic disc capacitors including suffix a-f from the main parts list and the all band list. Many of these capacitors are connected to the ground plane, use the same technique for installation as you did for the resistors.
- Using a resistor offset install a ground link as indicated adjacent to L3a-f
- Fit and solder diodes D1-4, D6a-f. Make sure that the cathode band on the diode agrees with the band on the board component outline.
- Fit and solder L1,2
- Fit and solder IC1,2 and 3, be careful to observe the correct orientation of the device. The cut out in the component legend indicates the pin 1 end, also pin 1 is further identified by a square pad on the track side. The following pins are soldered to the ground plane side of the pcb:- IC1 pin3, IC2 pin8,9.
- Fit and solder IC4. Bend the center pin at a right angle and solder to the ground plane. Make sure that the IC outline agrees with the board legend.
- Fit and solder VR1,2. solder one leg to the ground plane as indicated by the ground legend.
- Fit and solder TR1,4,5 and 6. Make sure the transistor shape agrees with the board outline.
- Make up T1 on the small ferrite tube bead. Cut 2 x mm lengths of the 32swg enameled copper wire and wind on both wires together to give six parallel turns [6 turns bifilar]. Identify the two windings and install one between IC1 pins 4/5 and the other between ground and the junction of C5/L1 [hole adj R2]
- Make up T3 on the 2 hole balun core. Dot one tube end with a felt tip marker or paint to indicate the start winding. Cut 13cm of the 32swg copper wire and wind on 6 turns [one turn up through tube and back down through the other] Remove the enamel from the finish end and tin the wire with solder. Cut another 5 cm of the 32swg wire. Clean and solder one end to tinned end of the 6 turn winding to form a tail. Wind on a further 2 turns. Clean and tin the start and new finish winding tails.
- Install with the six turns between the un-etched ground hole and the center hole of T3 outline.
- Make up T2 on the 6.3mm self colour core. Wind on 5 turns of the 32swg enameled copper wire. Clean the enamel from the wire and tin both ends of the winding. Cut another length and wind on 2 turns, remove the enamel but do not tin yet to aid identification.

- Install with 5 turns on R22 side of the ledgend outline and 2 turns between ground and hole adj to C11.
- Refer to the band pack parts table and install the suffix A list for the VCO and XTAL OSC.
- Where S18 inductors [2 lead heavy gauge winding with no can] are used the coil should be fitted between the diagnol lines inside the ledgend box outline.
- Fit and solder TR2a,3a. These are static sensitive devices, but in practice are quite robust. However its wise to adopt the standard precautions. Dont wear nylon clothing. Discharge any body static electricity by touching a water or a central heating pipe. Use an insulated soldering iron or fit a ground wire back to the pcb ground track. Dont wave the device about or handle the leads directly. Use insulated pliers to spread the leads. When fitting make sure the transistor outline matches the board ledgend.
- Fit and solder D5a. When fitting make sure the diode outline matches the board ledgend. The grouded lead should be bent at a right angle and solderd to the groundplane.
- Fit and solder X1a.
- It is recommended that you now move to test and alignment section brfore installing further band packs.
- Install the next band pack following the above procedure.

Test and Alignment

- Check the completed PCB for solder splashes, bridged tracks or pads and dry joints. If you suspect a dry joint use a multimeter to carry out a resistance check between the track and the component lead on the ground plane side.
- Connect the BSa pin to a 13.8v dc supply via a multimeter on its current range . Check that the current drawn is less than ma. If the current greatly exceeds this check for an incorrectly fitted diode or transistor.
- Check with a frequency counter or general coverage receiver that the xtal oscillator is functioning. Adjust the core of L4a for the highest frequency possible . Next adjust adjust C27a to bring the oscillator onto frequency. VR3 will need to be at mid range to get a reliable signal.
- Make a temporary connection to the pin on the L3a side of TP1 and connect to a 6 volt supply. [you may use a 13.8v supply via divider formed from a 10k pot and a 10k resistor to ground, te wiper will provide a variable voltage]

- Check with a frequency counter or general coverage receiver that the VCO oscillator is functioning. The frequency will not be stable but should be close to the required output. Adjust the core of L3a to bring it as close as possible. VR1 will need to be at mid range to get a reliable signal.
- Disconnect the temporary supply to TP1 and fit a wire link across the pins
- Connect a 5-5.5mhz vfo to the VFO input pin.
- Connect the +12v pin to a maximum of a 13.8v dc supply via a multimeter on its current range. Check that the current drawn is less than 100ma. If the current greatly exceeds this check for an incorrectly fitted diode, transistor or ic.
- Set VR1,2,3 to full range above ground.
- Attach normally to the 12v pin and now meter the voltage at TP1
- Set the VFO to 5.25mhz and adjust the core of L3a for 5v at TP1. The output frequency at the SYN OUT pin should in band with the khz portion at 250khz.
- Set the vfo to its upper and lower limits and check that the TP1 voltage is in the range 3-9 volts.
- This completes the alignment of the A band pack and the next pack may now be fitted and tested.

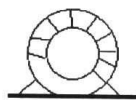
Band Pack Parts List

BAND	C20	L3	C25	C26	C27	L4	X1	D7
1.8		9444	0				16	
3.5	0	9445	0	47P	CTG	KANK333	18	Y
7.0	0	9448	0	47P	CTG	KANK3335	21.5	Y
10	27	9452					24.5	
14.0	56P	8.5T WHITE	2P2	18P	CTG	KANK3335	28.5	Y
18	39	7.5T VILOT					32.5	
21.0	27	7.5T VIOLET	2P2	33P	CTG	8.5T WHITE	35.5	Y
24.5	22	6.5T BLUE					39.0	
28.5	22	5.5T GREEN	0	22P	CTG	8.5T WHITE	43.0	N

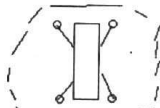
CTG = 30 PF GREEN TRIMMER (NOT REQUIRED ON DDS SYSTEM)

Parts List

R1,4,5,7,29	100R	C29	1N
R2	3K3	IC1	NE602
R3	8K2	1C2	74HCT4046
R6	1K8	IC3	TL072
R8	1K5	IC4,5	78L05
R9,11,13	10K	TR1	BC183
R10	470K	TR4	J310
R12	820RL	TR5,6	BSX20
R14,15	1K	D1,2,3,4,	1N4148
R22	10R	T1	FX115
R23	56R	T2	KX37830
R24,26	6K8	T3	BLN43002402
R25,27	47R	L1,2	22uH 7BS
R28	680R		
R30	15K	vco/xtal osc all band parts suffix A-E	
R31	22R	R16	10K
R32	220R	R17,18	100K
R33	33K	R19	100R
VR1,3	4K7	R20	220R
VR2	1K	R21	33K
C1,2,8,9,12,13,14,,16,18,28	10N	C19	1N
30,31,32,34,35,36	100N	C21,22	68P
C3,4,10,11,15	22P	C23,24	10N
C5,7	68P	TR1,2	J310
C6	1N5	D5	BB204
C17		D6	BA243



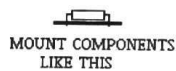
MOUNTING METHOD FOR TRANSFORMERS
AND INDUCTORS



NOT LIKE THIS



THIS IS 1 TURN
ON A TOROID



MOUNT COMPONENTS
LIKE THIS



SOLDER XTAL CANS
TO GROUNDPLANE



WHEN THIS SYMBOL
IS SHOWN



MOUNT THE COMPONENT
LIKE THIS



OR LIKE THIS

- ° Check with a frequency counter or general coverage receiver that the VCO oscillator is functioning. The frequency will not be stable but should be close to the required output. Adjust the core of L3a to bring it as close as possible. VR1 will need to be at mid range to get a reliable signal.
- ° Disconnect the temporary supply to TP1 and fit a wire link across the pins
- ° Connect a 5-5.5mhz vfo to the VFO input pin.
- ° Connect the +12v pin to a maximum of a 13.8v dc supply via a multimeter on its current range. Check that the current drawn is less than 100ma. If the current greatly exceeds this check for an incorrectly fitted diode, transistor or ic.
- ° Set VR1,2,3 to full range above ground.
- ° Attach normally to the 12v pin and now meter the voltage at TP1
- ° Set the VFO to 5.25mhz and adjust the core of L3a for 5v at TP1. The output frequency at the SYN OUT pin should in band with the khz portion at 250khz.
- ° Set the vfo to its upper and lower limits and check that the TP1 voltage is in the range 3-9 volts.
- ° This completes the alignment of the A band pack and the next pack may now be fitted and tested.

Band Pack Parts List

BAND	C20	L3	C25	C26	C27	L4	X1	D7
1.8		9444	0				16	
3.5	0	9445	0	47P	CTG	KANK333	18	Y
7.0	0	9448	0	47P	CTG	KANK3335	21.5	Y
10	27	9452					24.5	
14.0	56P	8.5T WHITE	2P2	18P	CTG	KANK3335	28.5	Y
18	39	7.5T VIOLET					32.5	
21.0	27	7.5T VIOLET	2P2	33P	CTG	8.5T WHITE	35.5	Y
24.5	22	6.5T BLUE					39.0	
28.5	22	5.5T GREEN	0	22P	CTG	8.5T WHITE	43.0	N

CTG = 30 PF GREEN TRIMMER (NOT REQUIRED ON DDS SYSTEM)

